

# FDD390N15ALZ N-Channel PowerTrench<sup>®</sup> MOSFET 150 V, 26 A, 42 mΩ

### Features

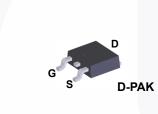
- R<sub>DS(on)</sub> = 33.4 mΩ (Typ.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 26 A
- R<sub>DS(on)</sub> = 42.2 mΩ (Typ.) @ V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 20 A
- Fast Switching Speed
- Low Gate Charge, Q<sub>G</sub> = 17.6 nC (Typ.)
- High Performance Trench Technology for Extremely Low  $R_{\text{DS}(\text{on})}$
- · High Power and Current Handling Capability
- RoHS Compliant

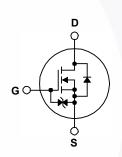
## Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

### Applications

- Consumer Applicances
- LED TV
- Synchronous Rectification
- Uninterruptible Power Supplies
- Micro Solar Inverter





### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

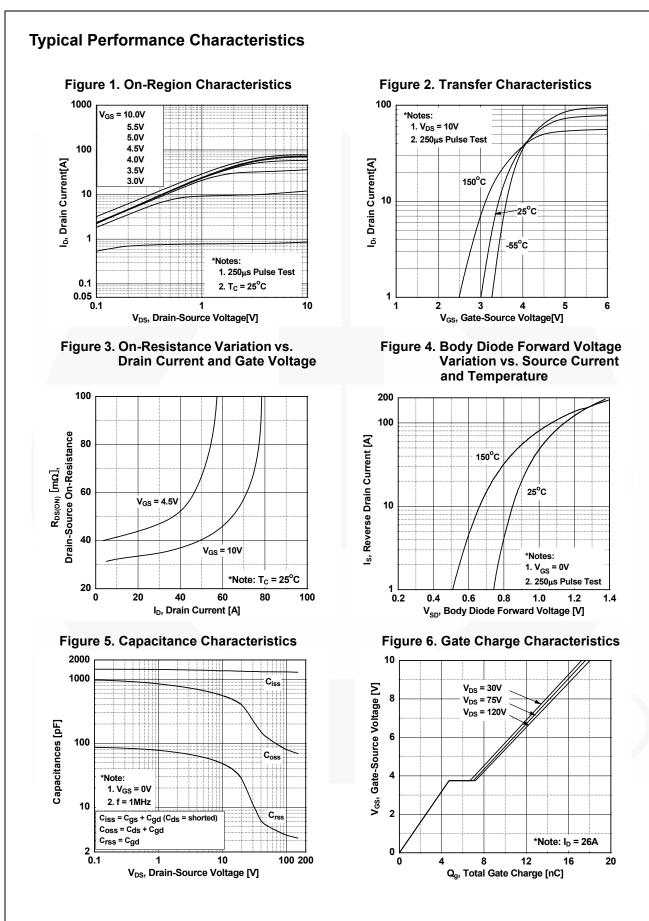
Symbol	Parameter		FDD390N15ALZ	Unit	
V <sub>DSS</sub>	Drain to Source Voltage		150	V	
V <sub>GSS</sub>	Gate to Source Voltage		±20	V	
ID	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)	26	•	
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)	17	A	
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)	104	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		96	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		13	V/ns	
P <sub>D</sub>	Dewer Dissignation	(T <sub>C</sub> = 25°C)	63	W	
	Power Dissipation	- Derate Above 25°C	0.5	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temperatur	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		°C	

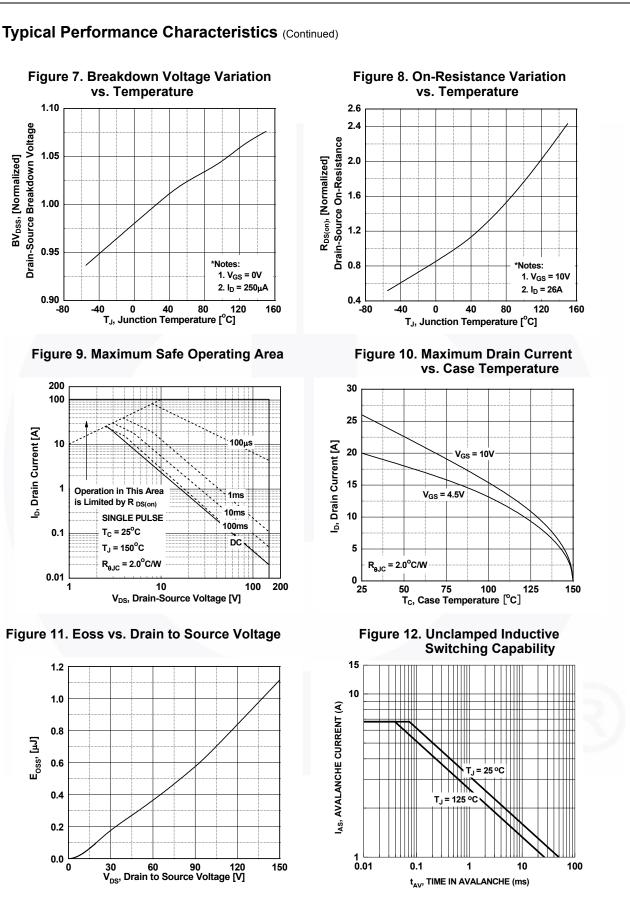
### **Thermal Characteristics**

Symbol	Parameter	FDD390N15ALZ	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.0	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	87	°C/W

Part Nur	Part Number Top Mark Pa		Package	Packing Methe	od Reel Size	Тар	e Width	Qua	ntity
FDD390N <sup>2</sup>	15ALZ	FDD390N15ALZ	DPAK	Tape and Ree	el 330 mm	1	6 mm	2500 units	
Electrica	I Chai	racteristics T <sub>C</sub> = 2	5 <sup>o</sup> C unless of	herwise noted.					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristic	cs							
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		age	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V		150	-	-	V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient		-	$I_D = 250 \ \mu$ A, Referenced to $25^{\circ}$ C		-	0.15	-	V/ºC
IDSS	Zero G	Zero Gate Voltage Drain Current		V <sub>DS</sub> = 120 V, V <sub>GS</sub> =		-	-	1	μA
		-		V <sub>DS</sub> = 120 V, T <sub>C</sub> =		-	-	500	
I <sub>GSS</sub>	Gate to	o Body Leakage Current	ľ	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> =	= 0 V	-	-	±10	μA
On Charac	teristic	s							
V <sub>GS(th)</sub>	Gate T	hreshold Voltage		V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 25		1.4	-	2.8	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance $V_{GS} = 10 \text{ V}, I_D = 26 \text{ A}$			-	33.4	42	mΩ		
NDS(on)	Static	Static Drain to Source On Resistance		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 20 A		-	42.2	64	mΩ
9 <sub>FS</sub>	Forwar	rd Transconductance	'	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 26 A		-	50	-	S
Dynamic C	haract	eristics							
C <sub>iss</sub>		Capacitance		V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	1323	1760	pF
C <sub>oss</sub>	Output	Capacitance				-	93	120	pF
C <sub>rss</sub>	Revers	se Transfer Capacitance				-	4	6	pF
C <sub>oss(er)</sub>	Energy	Related Output Capacita	ince	V <sub>DS</sub> = 75 V, V <sub>GS</sub> =	0 V	-	165	-	pF
Q <sub>g(tot)</sub>	Total G	ate Charge at 10V	,	V <sub>GS</sub> = 10 V	80		17.6	39	nC
Q <sub>g(tot)</sub>	Total G	ate Charge at 5V	,	V <sub>GS</sub> = 4.5 V			8.1	10.5	nC
Q <sub>gs</sub>	Gate to	o Source Gate Charge					4.7	-	nC
Q <sub>gd</sub>	Gate to	Drain "Miller" Charge					2.3	-	nC
ESR	Equiva	lent Series Resistance (G	i-S)	f = 1 MHz		-	1.48	-	Ω
Switching	Charac	cteristics							
t <sub>d(on)</sub>	1	n Delay Time				-	12.8	35.6	ns
t <sub>r</sub>		n Rise Time		$V_{DD}$ = 75 V, I <sub>D</sub> = 26 A, $V_{GS}$ = 10 V, R <sub>G</sub> = 4. 7Ω (Note 4)		-	9.3	28.6	ns
t <sub>d(off)</sub>	Turn-O	ff Delay Time				7-	26.9	63.8	ns
t <sub>f</sub>	Turn-O	ff Fall Time				-	3.2	16.4	ns
								1	
		de Characteristics	ouroo Diodo	Forward Current				26	•
I <sub>S</sub>	Maximum Continuous Drain to Source Dio					-	-	104	A
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode F Drain to Source Diode Forward Voltage					-	-	1.25	V
V <sub>SD</sub>		e Recovery Time		$V_{GS} = 0 V, I_{SD} = 26 A$ $V_{GS} = 0 V, I_{SD} = 26 A,$ $dI_{F}/dt = 100 A/\mu s$		-	70	1.25	ns
trr		e Recovery Charge				-	169		nC
Q <sub>rr</sub>	1.00013	o noovery onarge					100		10

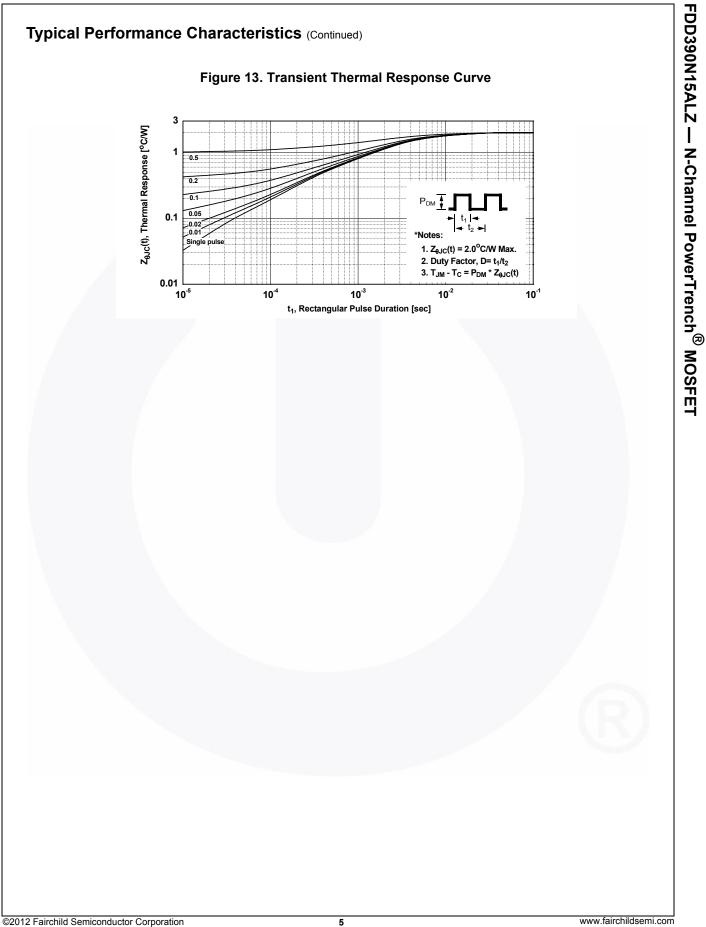


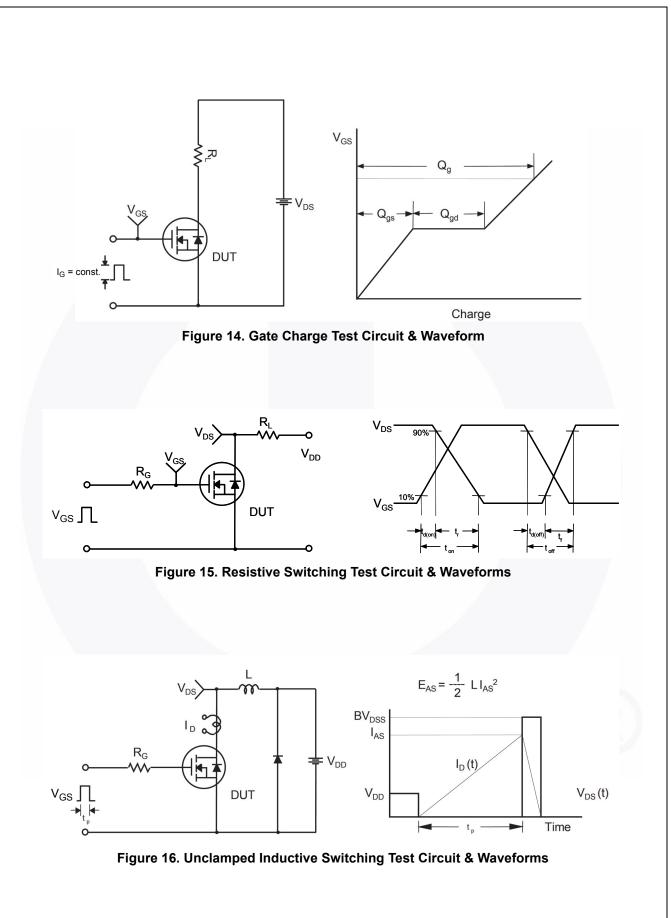




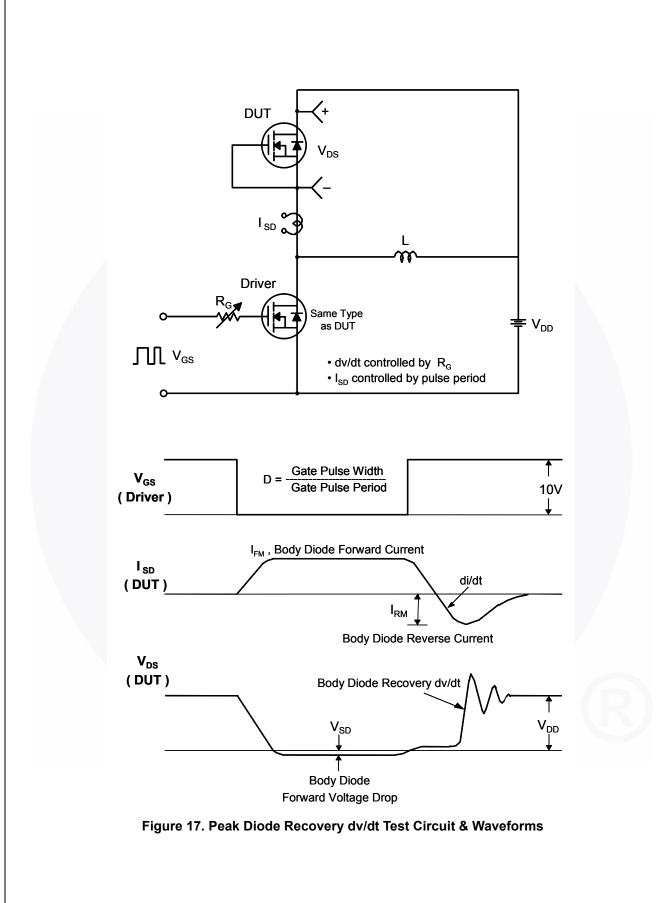
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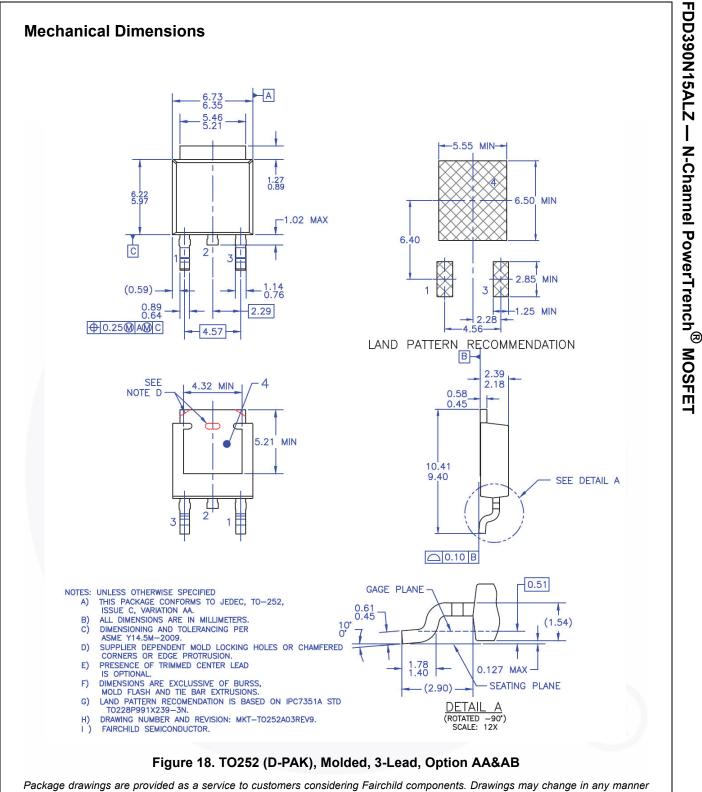




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